



US00D791114S

(12) **United States Design Patent** (10) **Patent No.:** **US D791,114 S**
Lee et al. (45) **Date of Patent:** **** Jul. 4, 2017**

(54) **COVER FOR ELECTRONIC COMMUNICATIONS DEVICE**

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(*) Notice: This patent is subject to a terminal disclaimer.

(**) Term: **14 Years**

(21) Appl. No.: **29/522,141**

(22) Filed: **Mar. 27, 2015**

(30) **Foreign Application Priority Data**

Feb. 16, 2015 (KR) 30-2015-0008454

(51) **LOC (10) Cl.** **14-03**

(52) **U.S. Cl.**
USPC **D14/250**

(58) **Field of Classification Search**
USPC D14/238.1, 440, 203.3-203.7, 217, 240, D14/248, 251-253, 447, 496, 250;
(Continued)

(56) **References Cited**

U.S. PATENT DOCUMENTS

D637,589 S * 5/2011 Willes D14/250
D652,829 S * 1/2012 Kim D14/250
(Continued)

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(57) **CLAIM**

The ornamental design for a cover for electronic communications device, as shown and described.

DESCRIPTION

FIG. 1 is a top left front perspective view of a first embodiment of a cover for electronic communications device showing our new design;
FIG. 2 is a front view thereof;
FIG. 3 is a rear view thereof;
FIG. 4 is a left-side elevation view thereof;
FIG. 5 is a right-side elevation view thereof;
FIG. 6 is a top plan view thereof;
FIG. 7 is a bottom plan view thereof;
FIG. 8 is an enlarged rear view of the area in FIG. 3 indicated by the lines A and B in FIG. 3 and also of the corresponding area in FIG. 13;
FIG. 9 is an enlarged top right rear perspective view of the area in FIG. 3 indicated by the lines A and B in FIG. 3 and also of the corresponding area in FIG. 13;
FIG. 10 is a top left front perspective view thereof, showing the first embodiment of a cover for an electronic device in an open position;
FIG. 11 is a top left front perspective view of a second embodiment of a cover for an electronic device showing our new design;
FIG. 12 is a front view thereof;
FIG. 13 is a rear view thereof;
FIG. 14 is a left-side elevation view thereof;
FIG. 15 is a right-side elevation view thereof;
FIG. 16 is a top plan view thereof;
FIG. 17 is a bottom plan view thereof; and,
FIG. 18 is a top left front perspective view thereof, showing the second embodiment of a cover for an electronic device in an open position.

The dashed broken lines in the drawing figures depict portions of the cover for an electronic communications device that form no part of the embodiment of the claimed design in which they are shown. The dashed broken lines and unshaded areas bounded by dashed broken lines form no part of the embodiment of the claimed design in which they are shown.

(Continued)



The lines marked A and B in FIG. 3 indicate a portion of the first and second embodiments of the claimed design that is illustrated in enlargements and form no part of the claimed design.

The dot-dot-dash broken lines in FIGS. 8 and 9 delineate a portion of the first and second embodiments of the claimed design that is illustrated in enlargements and form no part of the claimed design.

1 Claim, 13 Drawing Sheets

(58) Field of Classification Search

USPC D3/201, 218, 247, 269, 273, 301, 303;
 D13/103, 107-108, 119
 CPC H04B 1/3888; H04M 1/0283; H04M 1/0202;
 A45C 1/06; A45C 2011/002; A45C 11/00;
 A45C 13/02; A45F 2005/026; A45F
 2200/0525; A45F 2200/0516
 See application file for complete search history.

(56) References Cited

U.S. PATENT DOCUMENTS

D657,354 S * 4/2012 Kim D14/250

D674,799 S * 1/2013 Kim D14/440
 D678,260 S * 3/2013 Bau D14/132
 D679,694 S * 4/2013 Fahrendorff D14/250
 D686,199 S * 7/2013 Fahrendorff D14/250
 8,490,783 B1 * 7/2013 Fan H04M 1/185
 206/45.23
 D694,741 S * 12/2013 Kim D14/250
 D702,673 S * 4/2014 Murchison D14/250
 D704,689 S * 5/2014 Chang D14/250
 D706,753 S * 6/2014 Kim D14/250
 D711,861 S * 8/2014 Mei D14/250
 D712,393 S * 9/2014 Kim D14/250
 D714,053 S * 9/2014 Yoo D3/269
 D727,916 S * 4/2015 Melmon D14/440
 D728,552 S * 5/2015 Kim D14/250
 D728,553 S * 5/2015 Kim D14/250
 D760,708 S * 7/2016 Hirst D14/250
 2011/0290687 A1 * 12/2011 Han A45C 3/02
 206/320
 2012/0043234 A1 * 2/2012 Westrup A45C 3/02
 206/320
 2012/0085679 A1 * 4/2012 Kim A45C 3/001
 206/736

* cited by examiner

FIG. 1

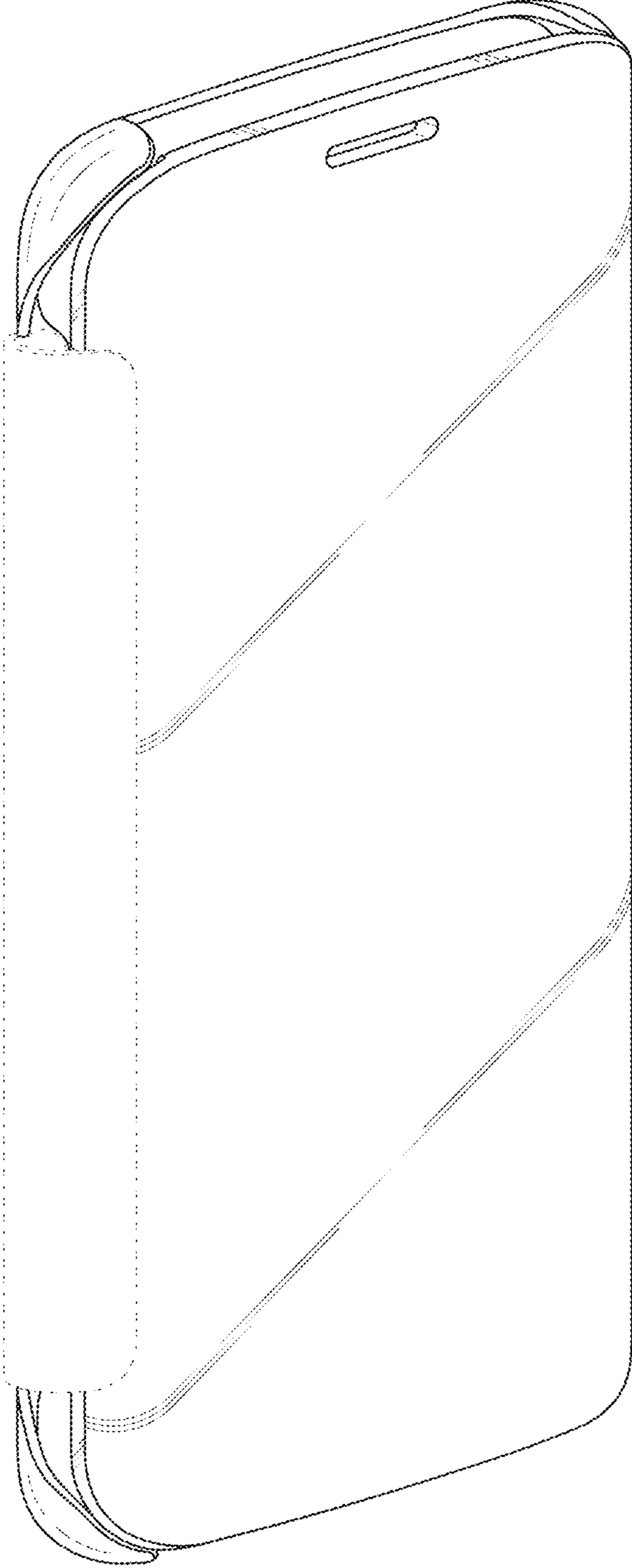


FIG.2

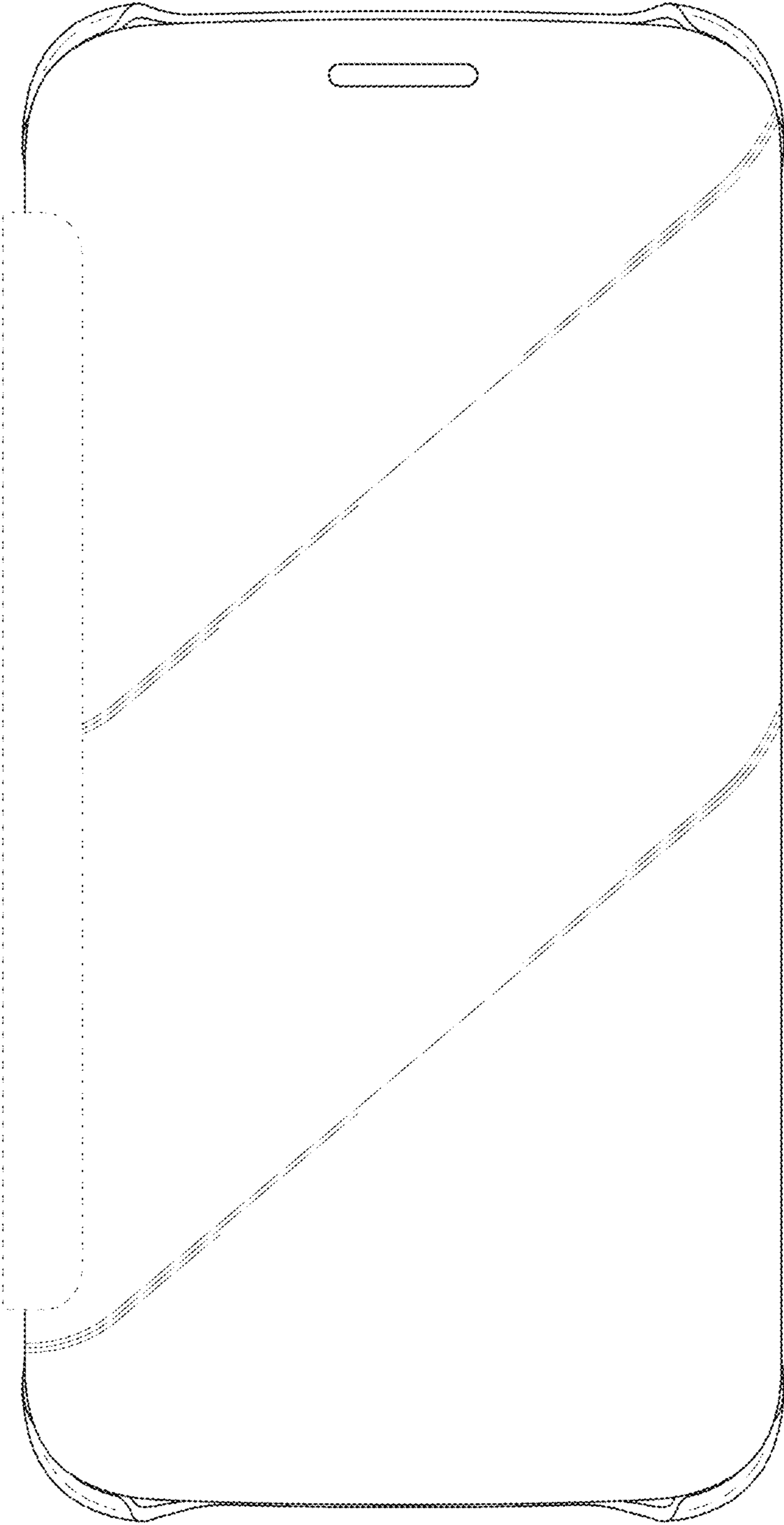


FIG.3

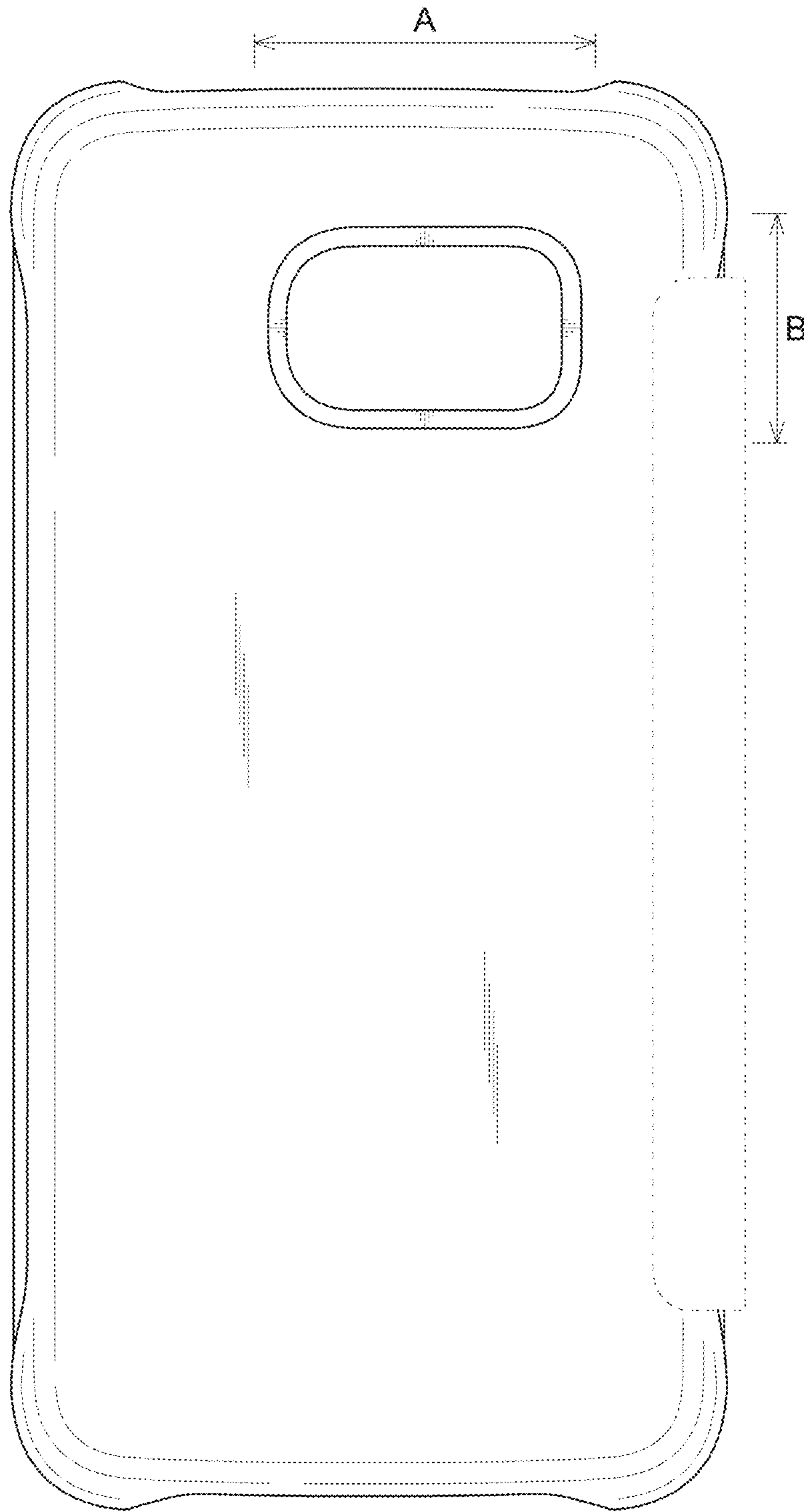


FIG.4

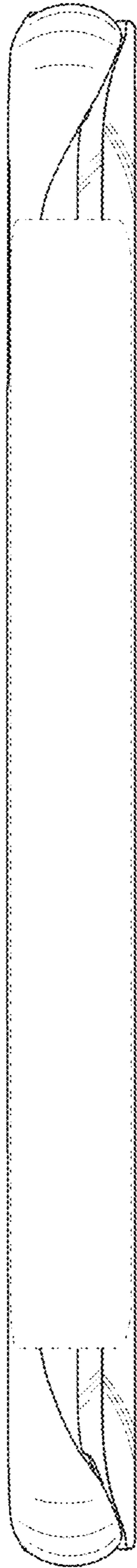


FIG.5

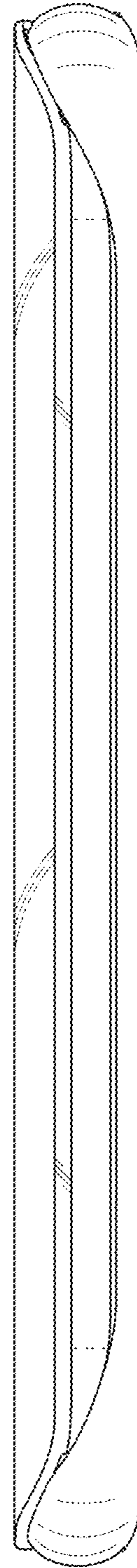


FIG.6

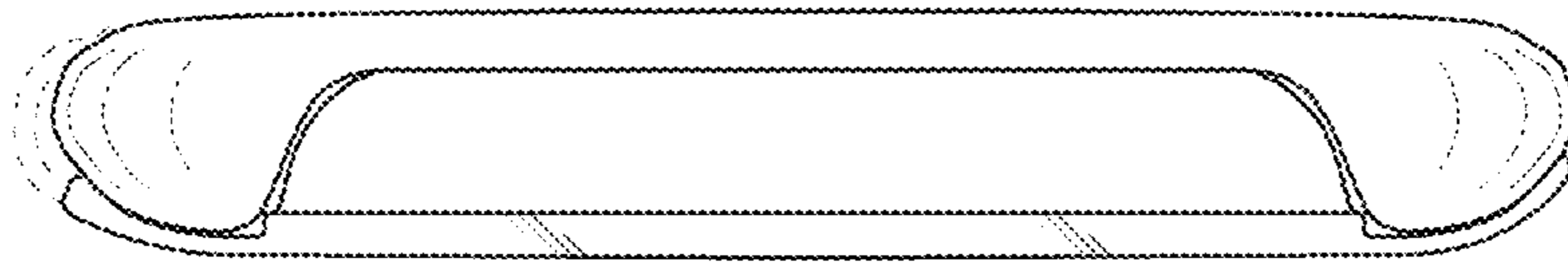


FIG.7

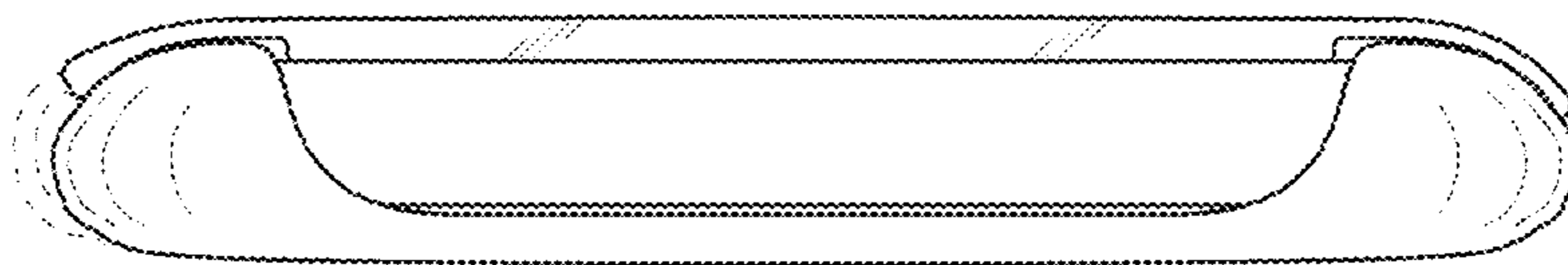


FIG.8

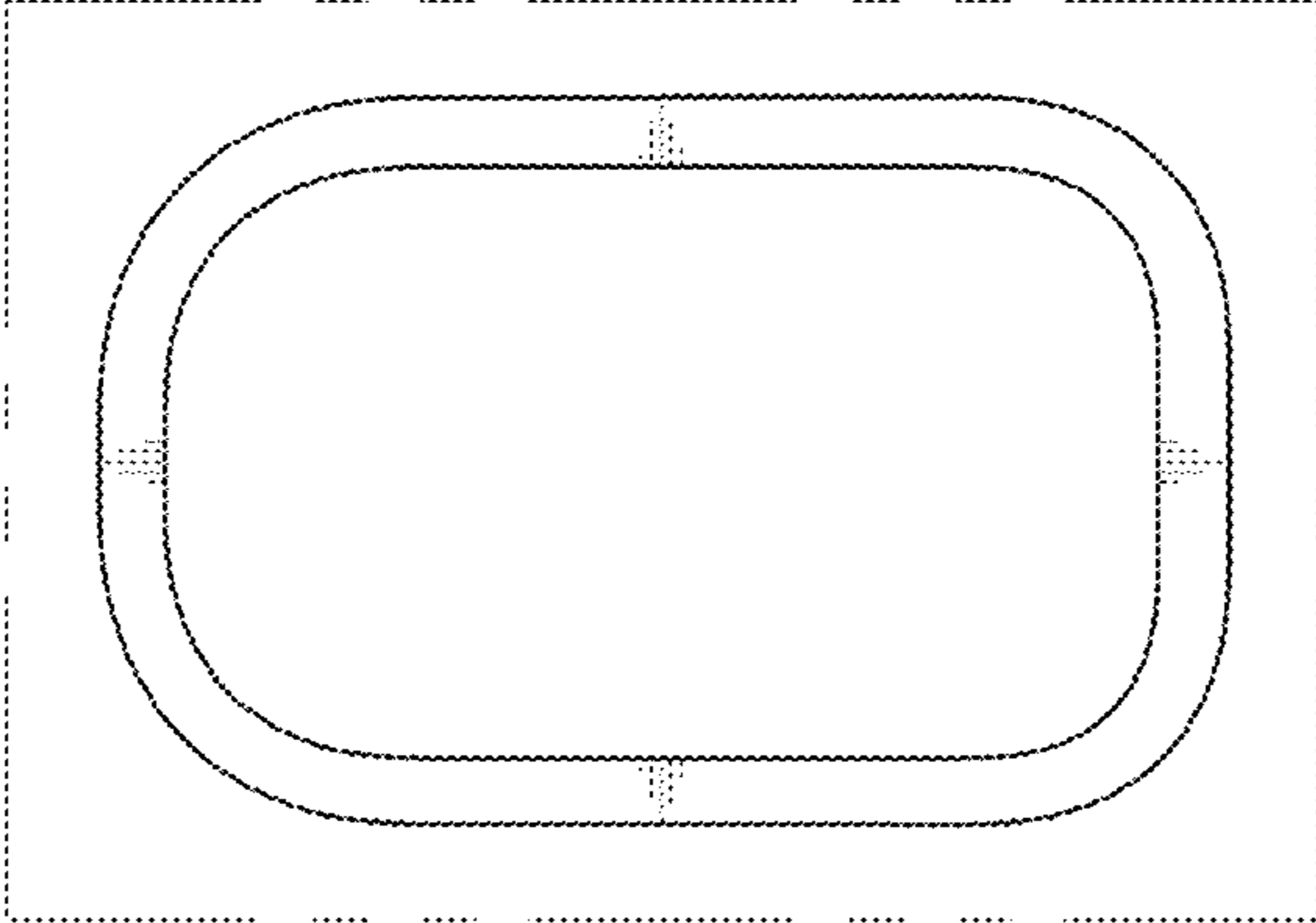


FIG.9

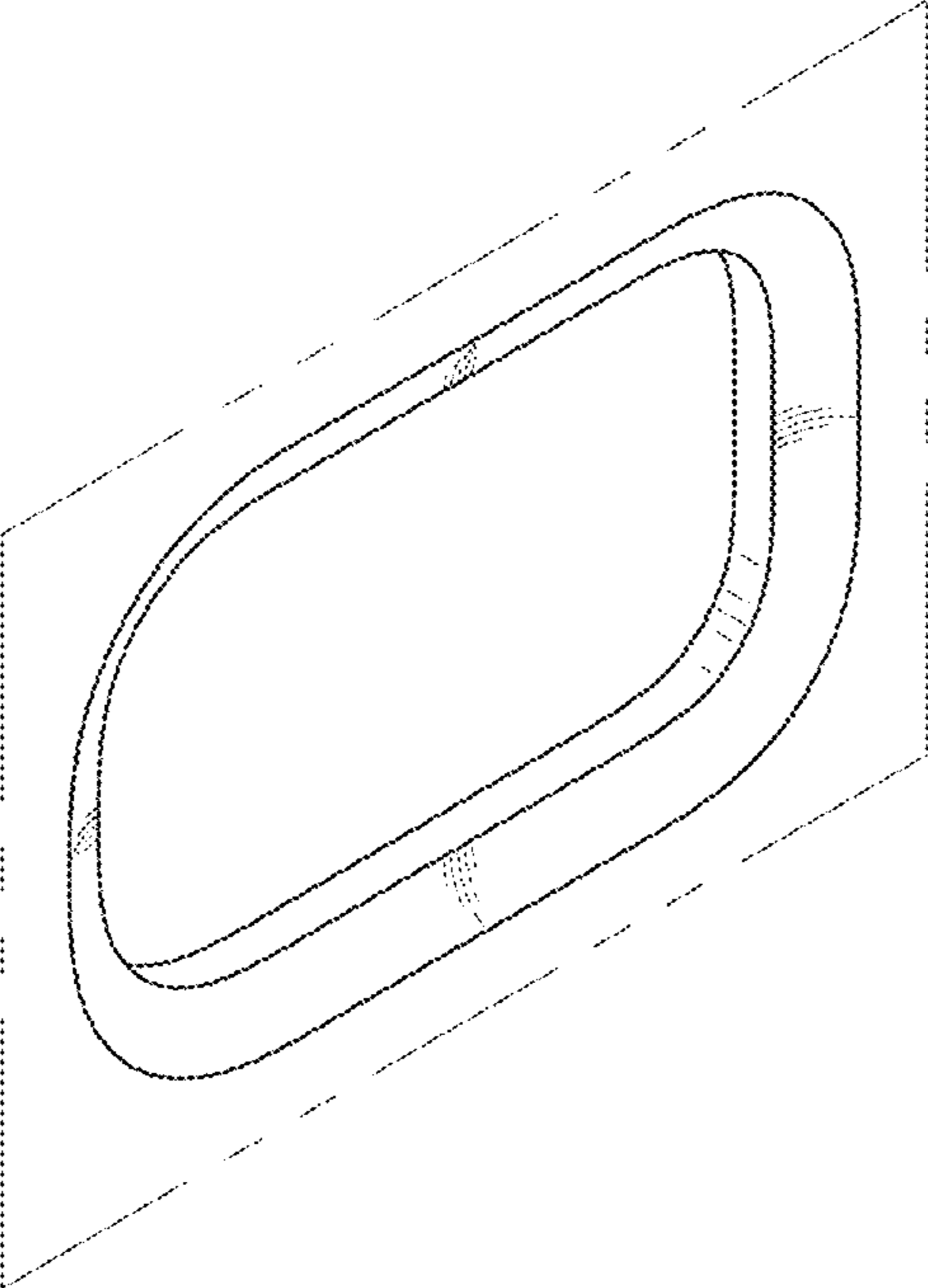


FIG. 10

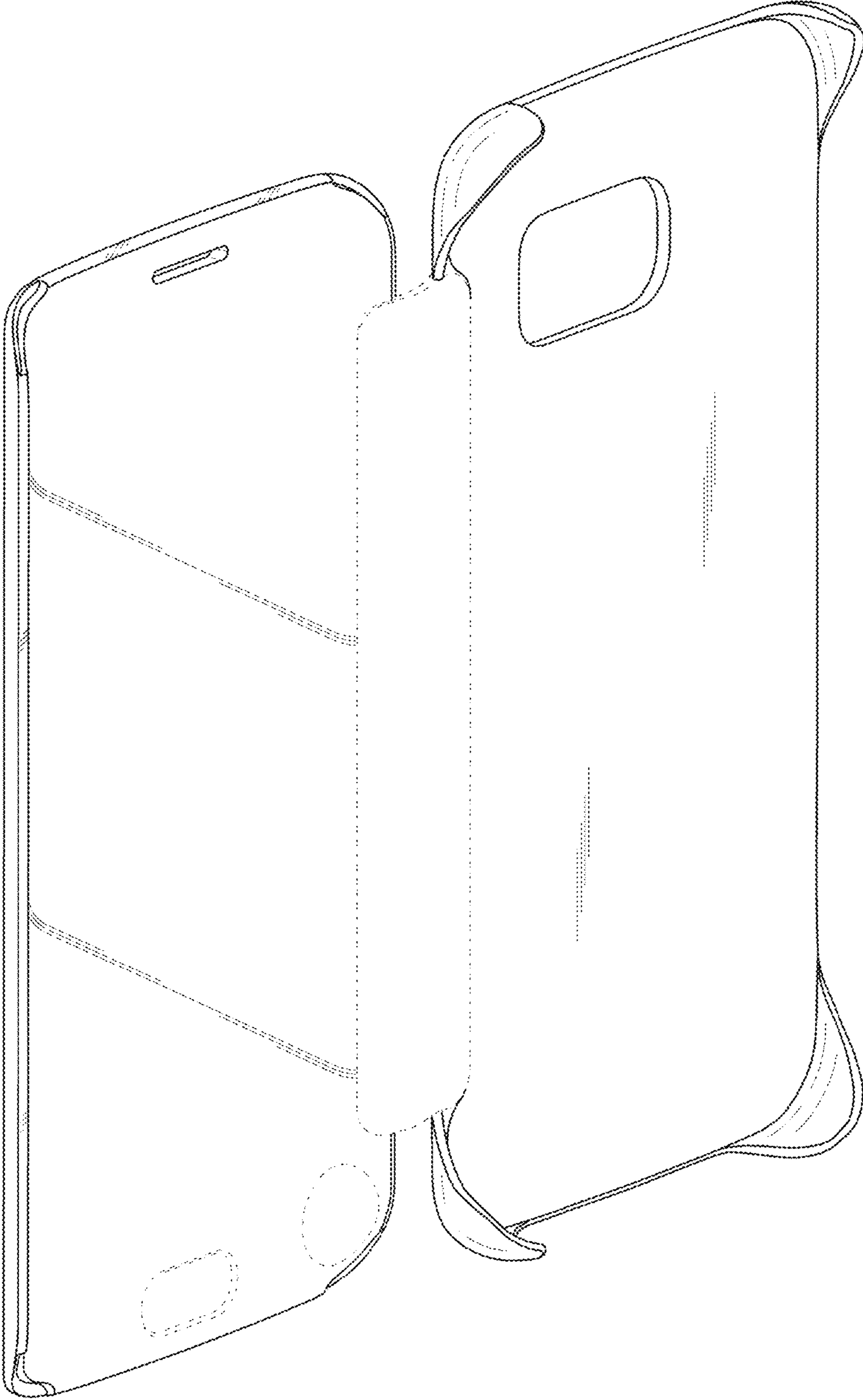


FIG. 11

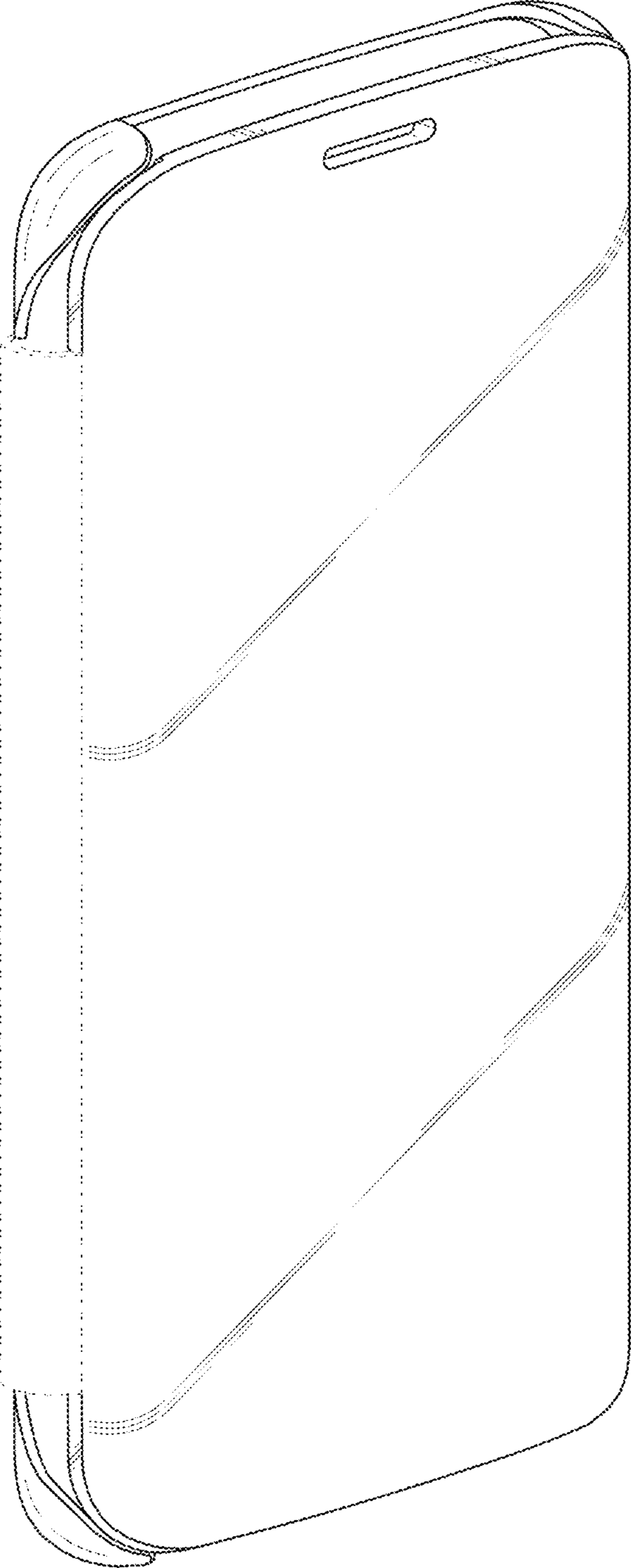


FIG.12

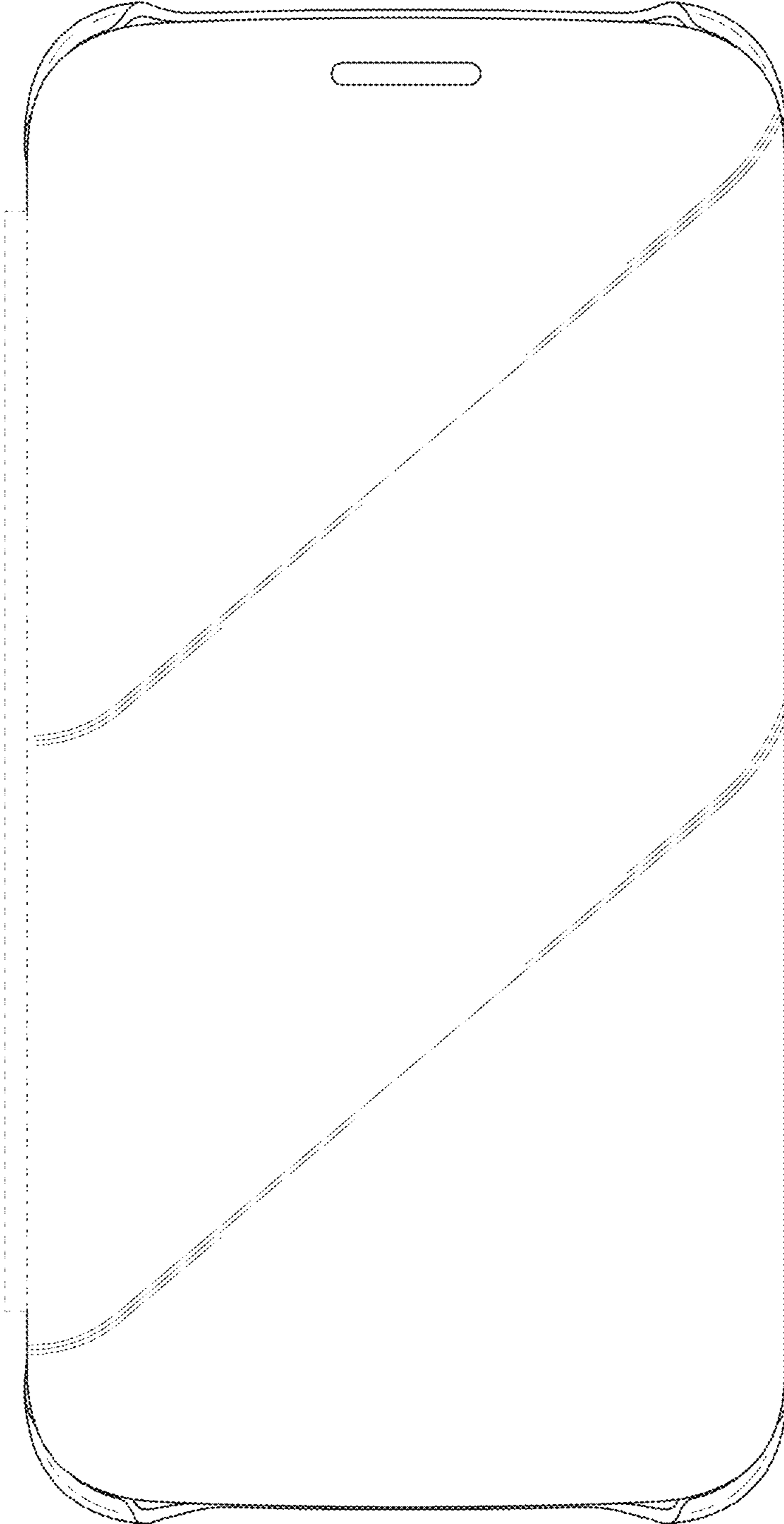


FIG. 13

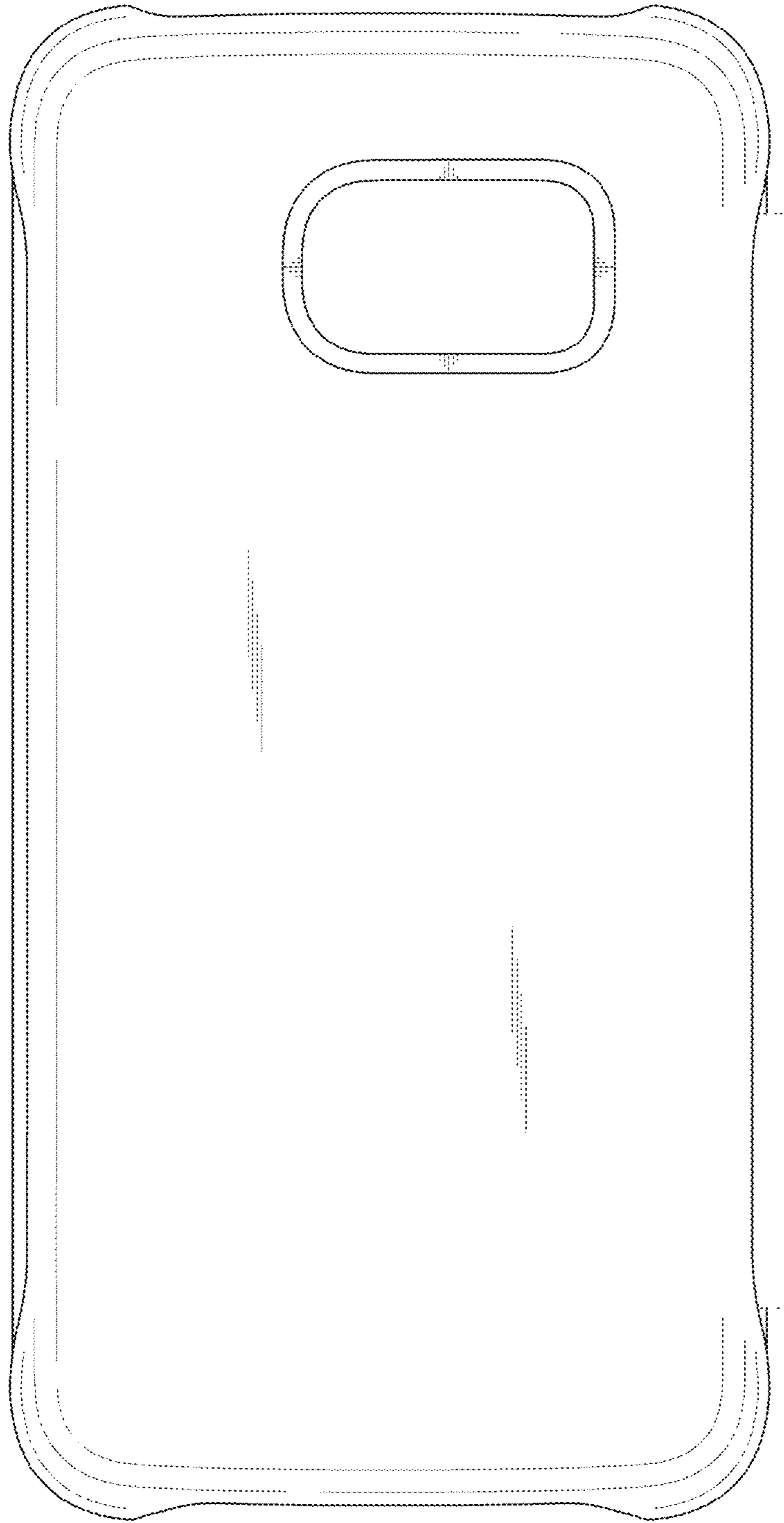


FIG.14

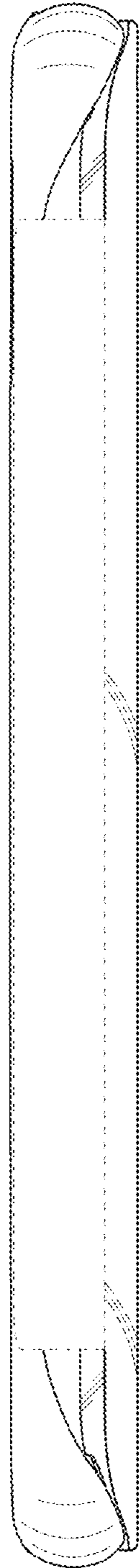


FIG.15

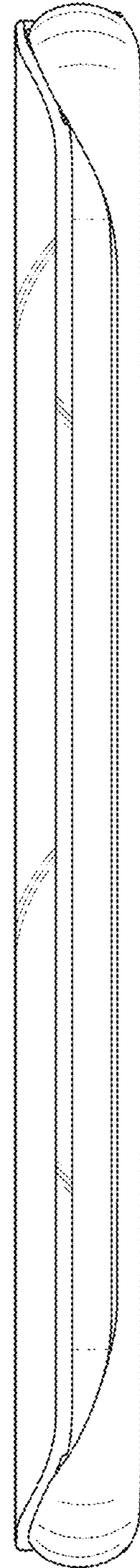


FIG.16

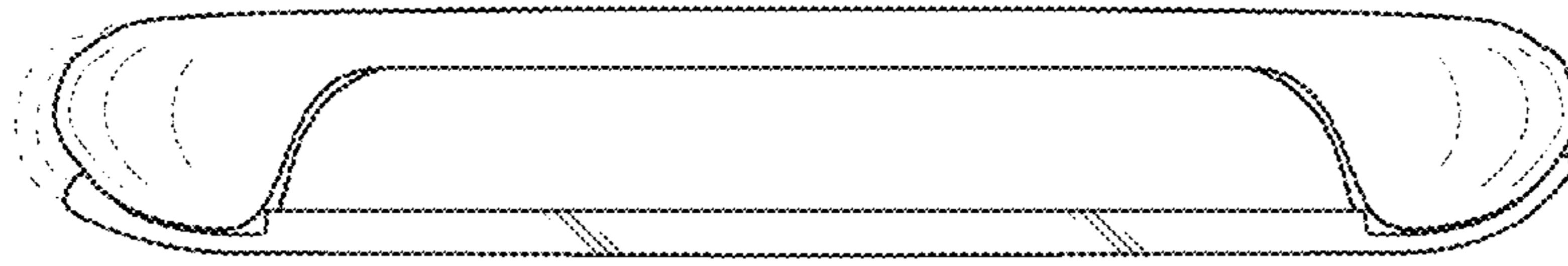


FIG.17

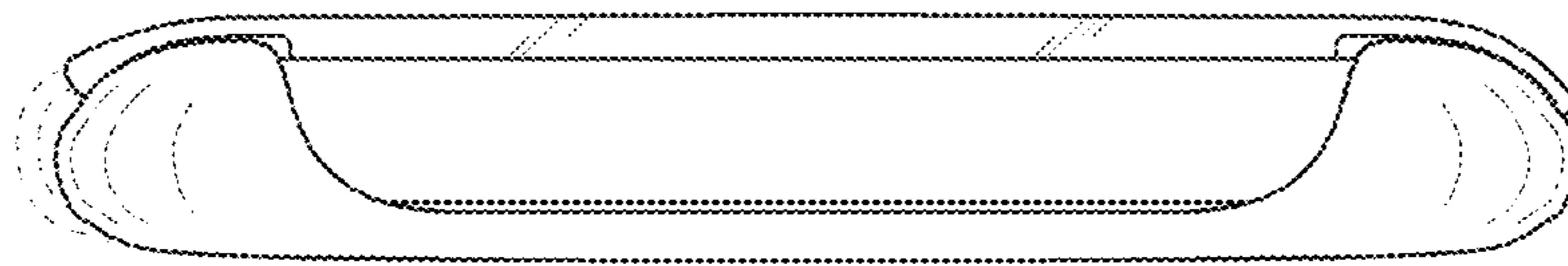


FIG. 18

